

TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type (U-MOS V)

TPCC8103

Notebook PC Applications

Portable Equipment Applications

- Small footprint due to a small and thin package
- Low drain-source ON-resistance:
 $R_{DS\ (ON)} = 9.4\ m\Omega$ (typ.) ($V_{GS} = -10\ V$)
- Low leakage current: $I_{DSS} = -10\ \mu A$ (max) ($V_{DS} = -30\ V$)
- Enhancement mode: $V_{th} = -0.8$ to $-2.0\ V$ ($V_{DS} = -10\ V$, $I_D = -1.0\ mA$)

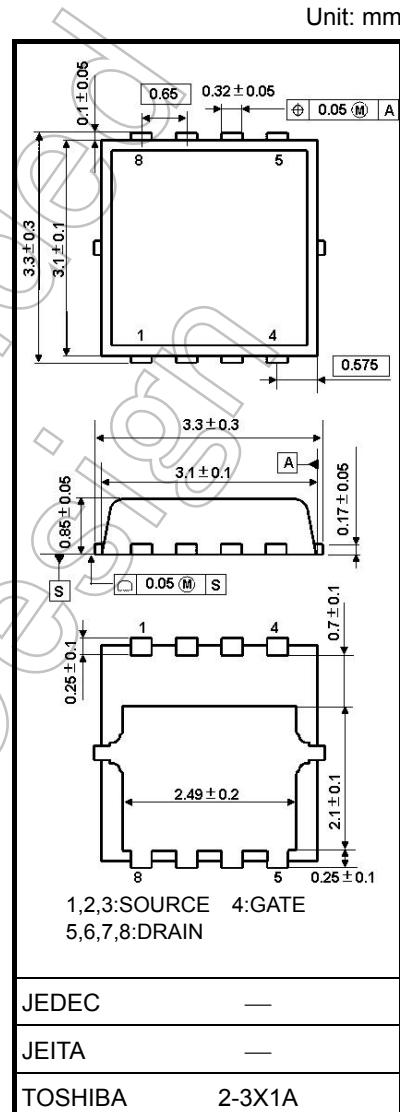
Absolute Maximum Ratings ($T_a = 25^\circ C$)

| Characteristic | Symbol | Rating | Unit |
|---|-----------------|------------|------|
| Drain-source voltage | V_{DSS} | -30 | V |
| Drain-gate voltage ($R_{GS} = 20\ k\Omega$) | V_{DGR} | -30 | V |
| Gate-source voltage | V_{GSS} | ± 20 | V |
| Drain current | DC (Note 1) | I_D | A |
| | Pulsed (Note 1) | I_{DP} | |
| Drain power dissipation ($T_c = 25^\circ C$) | P_D | 27 | W |
| Drain power dissipation ($t = 10\ s$) (Note 2a) | P_D | 1.9 | W |
| Drain power dissipation ($t = 10\ s$) (Note 2b) | P_D | 0.7 | W |
| Single-pulse avalanche energy (Note 3) | E_{AS} | 84 | mJ |
| Avalanche current | I_{AR} | -18 | A |
| Repetitive avalanche energy ($T_c = 25^\circ C$) (Note 4) | E_{AR} | 1.59 | mJ |
| Channel temperature | T_{ch} | 150 | °C |
| Storage temperature range | T_{stg} | -55 to 150 | °C |

Note: For Notes 1 to 4, refer to the next page.

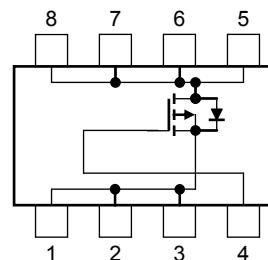
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.



Weight: 0.02 g (typ.)

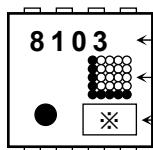
Circuit Configuration

Start of commercial production
2009-06

Thermal Characteristics

| Characteristic | Symbol | Max | Unit |
|--|-----------------|-----|---------------------------|
| Thermal resistance, channel to case ($T_c = 25^\circ\text{C}$) | R_{th} (ch-c) | 4.7 | $^\circ\text{C}/\text{W}$ |
| Thermal resistance, channel to ambient ($t = 10$ s) (Note 2a) | R_{th} (ch-a) | 66 | $^\circ\text{C}/\text{W}$ |
| Thermal resistance, channel to ambient ($t = 10$ s) (Note 2b) | R_{th} (ch-a) | 180 | $^\circ\text{C}/\text{W}$ |

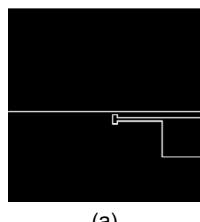
Marking (Note 5)



Part number
Product-specific code
Lot No.

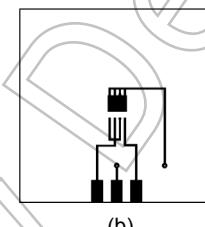
Note 1: Ensure that the channel temperature does not exceed 150°C .

Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



(a)

FR-4
25.4 x 25.4 x 0.8
(Unit: mm)



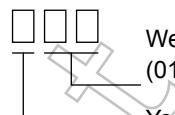
(b)

FR-4
25.4 x 25.4 x 0.8
(Unit: mm)

Note 3: $V_{DD} = -24$ V, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 200 \mu\text{H}$, $R_G = 25 \Omega$, $I_{AR} = -18$ A

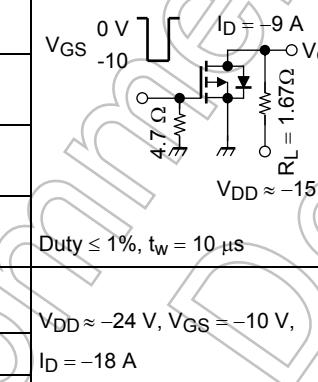
Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: * Weekly code: (Three digits)



Week of manufacture
(01 for the first week of the year, continuing up to 52 or 53)
Year of manufacture
(The last digit of the year)

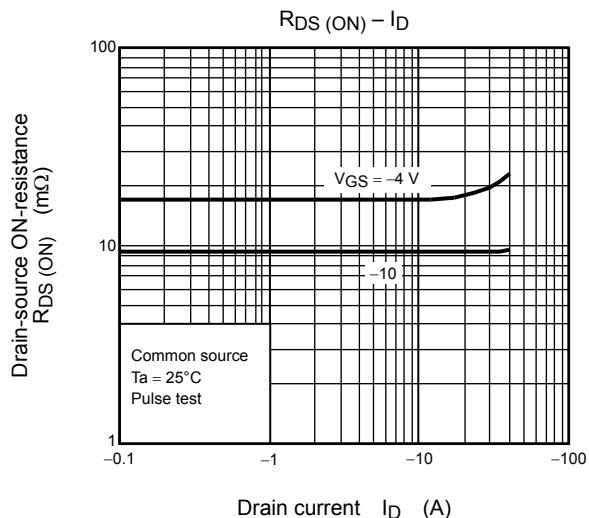
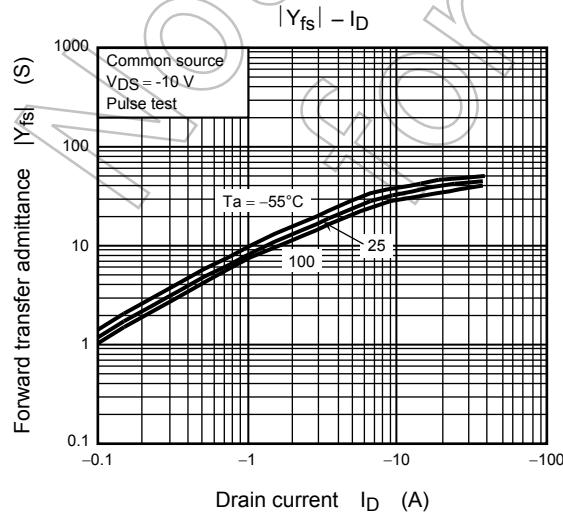
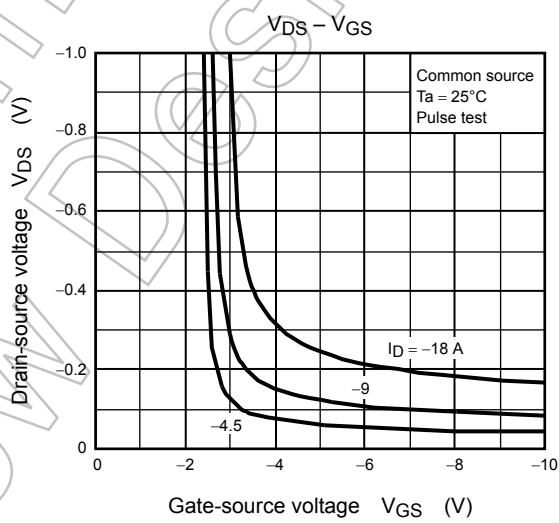
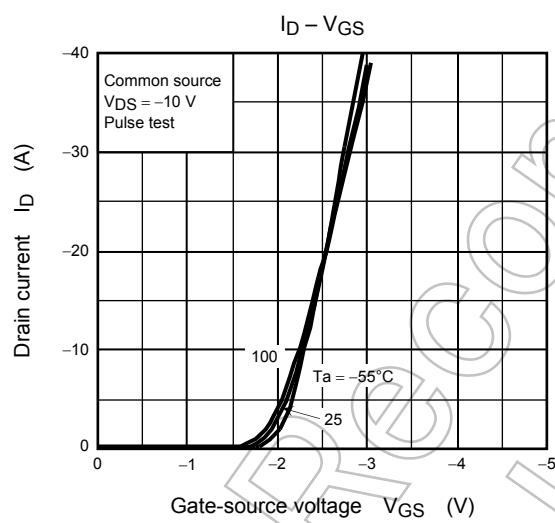
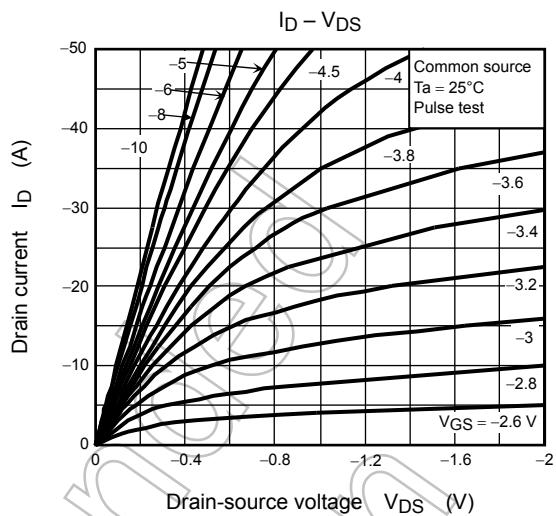
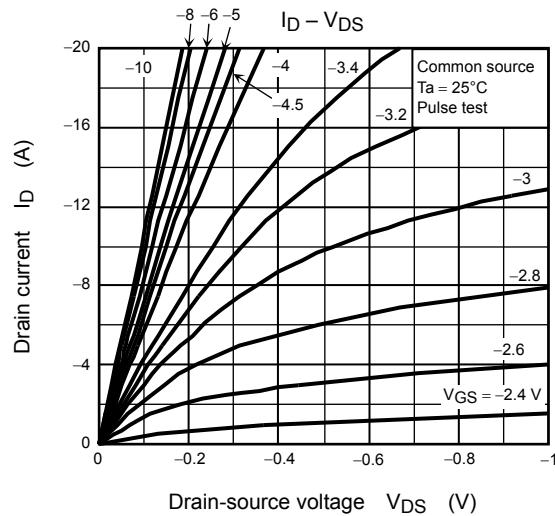
Electrical Characteristics ($T_a = 25^\circ\text{C}$)

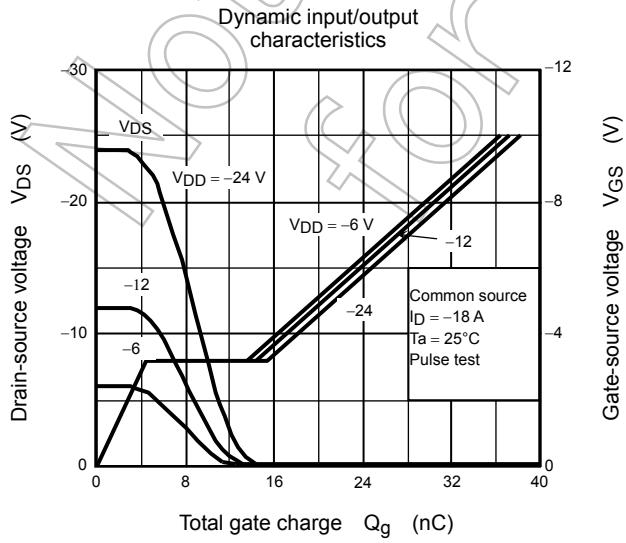
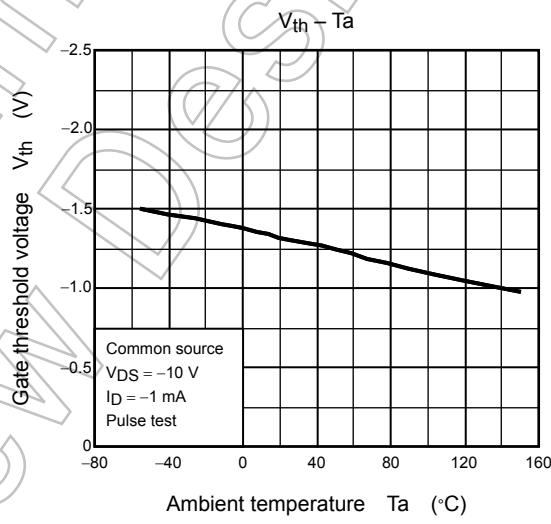
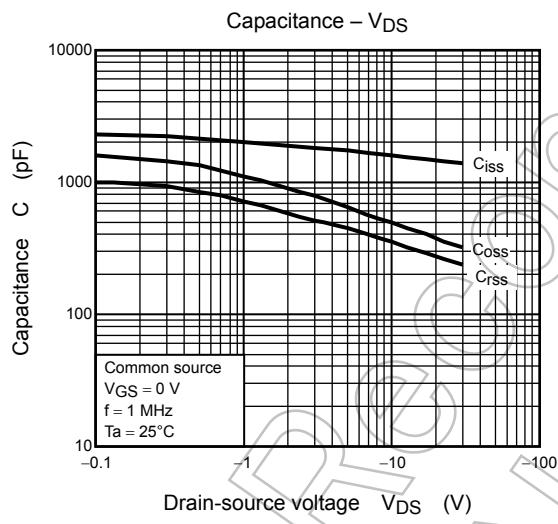
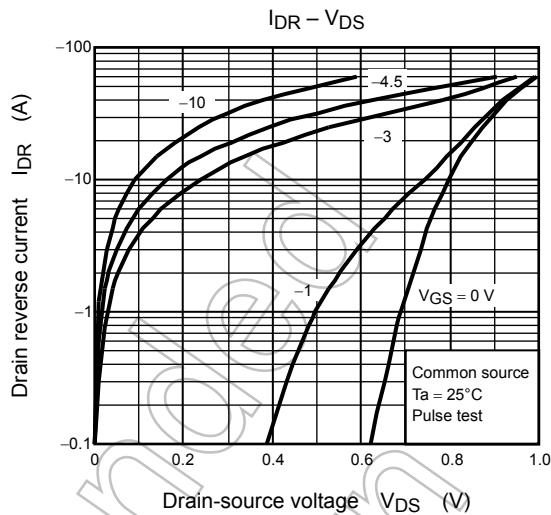
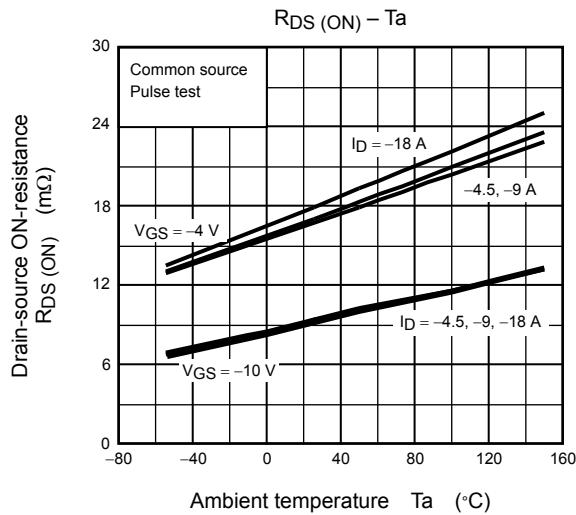
| Characteristic | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|-----------------------------|---|---|------|-----------|------------------|
| Gate leakage current | I_{GSS} | $V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{ V}$ | — | — | ± 100 | nA |
| Drain cutoff current | I_{DSS} | $V_{DS} = -30\text{ V}$, $V_{GS} = 0\text{ V}$ | — | — | -10 | μA |
| Drain-source breakdown voltage | $V_{(\text{BR})\text{DSS}}$ | $I_D = -10\text{ mA}$, $V_{GS} = 0\text{ V}$ | -30 | — | — | V |
| | $V_{(\text{BR})\text{DSX}}$ | $I_D = -10\text{ mA}$, $V_{GS} = 20\text{ V}$ | -13 | — | — | |
| Gate threshold voltage | V_{th} | $V_{DS} = -10\text{ V}$, $I_D = -1.0\text{ mA}$ | -0.8 | — | -2.0 | V |
| Drain-source ON-resistance | $R_{DS\text{ (ON)}}$ | $V_{GS} = -4\text{ V}$, $I_D = -9\text{ A}$ | — | 17 | 25 | $\text{m}\Omega$ |
| | | $V_{GS} = -10\text{ V}$, $I_D = -9\text{ A}$ | — | 9.4 | 12 | |
| Forward transfer admittance | $ Y_{fs} $ | $V_{DS} = -10\text{ V}$, $I_D = -9\text{ A}$ | 15 | 30 | — | S |
| Input capacitance | C_{iss} | $V_{DS} = -10\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$ | — | 1600 | — | pF |
| Reverse transfer capacitance | C_{rss} | | — | 340 | — | |
| Output capacitance | C_{oss} | | — | 490 | — | |
| Switching time | Rise time | t_r |  | 9.3 | — | ns |
| | Turn-on time | t_{on} | | 16 | — | |
| | Fall time | t_f | | 68 | — | |
| | Turn-off time | t_{off} | | 175 | — | |
| Total gate charge (gate-source plus gate-drain) | Q_g | $V_{DD} \approx -24\text{ V}$, $V_{GS} = -10\text{ V}$, $I_D = -18\text{ A}$ | — | 38 | — | nC |
| Gate-source charge 1 | Q_{gs1} | | — | 4.5 | — | |
| Gate-drain ("Miller" charge) | Q_{gd} | | — | 11 | — | |

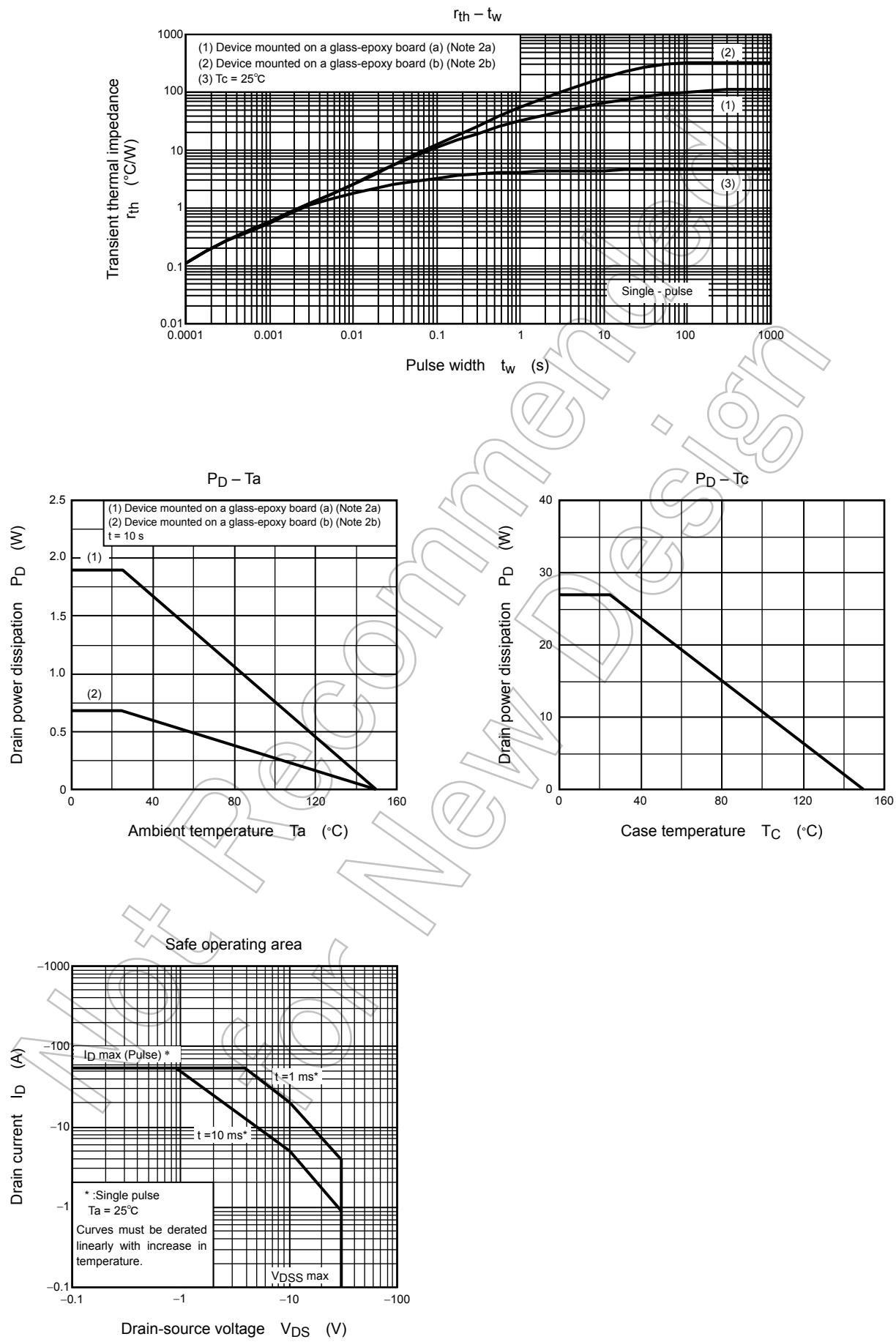
Source-Drain Ratings and Characteristics ($T_a = 25^\circ\text{C}$)

| Characteristic | Symbol | Test Condition | Min | Typ. | Max | Unit |
|-------------------------|-----------|----------------|---|------|-----|------|
| Drain reverse current | I_{DRP} | Pulse (Note 1) | — | — | -54 | A |
| Forward voltage (diode) | V_{DSF} | | $I_{DR} = -18\text{ A}$, $V_{GS} = 0\text{ V}$ | — | 1.2 | V |

Not for
Production







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